# McHF QRP Transceiver Build Guide

FOR RF BOARD 0.4 AND UI BOARD 0.4

W1BAW BRUCE WATTENDORF

#### MCHF Build Guide

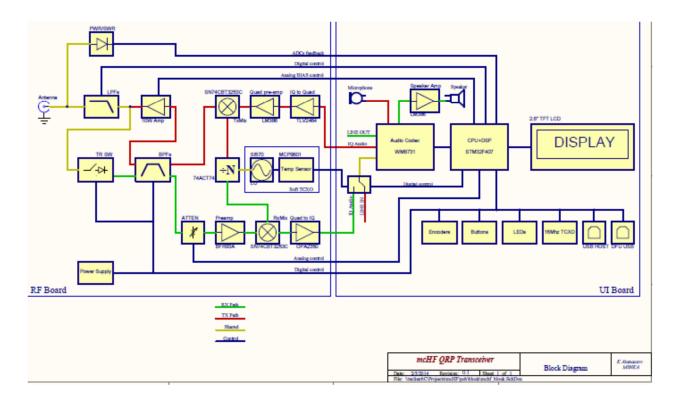
Description of radio and what to expect.
What you need to build
What you might want to get to make it easier.
Start building
Power section
On the Rf board solder F1, D1, C27, R11,R12, C30, R10, R13, R14, D2, U5, C28, C29, U4, U3, J1
Test by connecting up 12 volts to J1
Computer
Apply the firmware
Build the audio Codex
Build the local oscillator
Build the RX mixer
Build the Bandpass filter section
Build the antenna switching

The McHF radio is a QRP Amateur radio transceiver. It is a small, home-brew amateur radio project. It was designed to be as cheap as possible – without sacrificing functionality – and include the ability to add new features via simple software updates.

The choice of architecture is a direct conversion receiver and transmitter, with a small micro-controller to provide control and DSP functions. The analog blocks in this implementation were kept to the bare minimum. Shifting, as much as possible, functionality into the digital domain.

The receiver features: a SN74CBT3253C Tayloe detector as a direct conversion mixer – Local Oscillator frequency is four times higher than the receive frequency; a digitally switched band pass filter; voltage controlled attenuator and pre-amp situated in the RF signal path before the actual direct conversion process. The resulting IQ audio signals from the detector are sent to the WM8731 Codec for conversion to digital data, and then via I2S bus to the STM32F4 controller. The decoding of the different modes (SSB,AM and CW) is then performed by DSP routines inside the CPU. Finally, processed audio is sent back to the CODEC chip and outputted via the speaker or LINE OUT output.

The transmitter uses a reverse process of mixing four channels of audio data with the LO signal. The result is amplified by the linear amplifier and passed via digitally switched LPFs into the antenna output. As with the receiver, the CODEC processes audio from a microphone or LINE IN to convert it to digital data where it is sent on to the CPU for DSP processing. Here IQ data is generated and sent back to the CODEC. When in CW mode, software defined DDS is used to generate side-tone, controlled by an iambic keyer. Resulting IQ data is sent in the same way to the CODEC for conversion to analog signals and passed on to the tx mixer.



The architecture so far is no different than similar direct conversion QRP kits and projects. I have tried to further 'digitise' the design and add some ideas which might prove to be useful over time:

- Temperature sensor on the I2C bus, attached physically to the local oscillator(SI570).
   Small toxo routine in the firmware can help improve the frequency stability for digital modes
- Voltage controlled physical attenuator in front of the RF pre-amp, controlled by the CPU built in DAC, hopefully providing better control over strong signals
- Digitally controlled BIAS for the final linear amplifier simple PTT control, and no need for unreliable analog trimmer pots
- LPF switching via latch relays lower power consumption avoiding thermal strain on the contacts
- Keypad with each button connected to separate GPIO pin instead of scanning matrix keyboard – lower noise and intermodulation products
- Single CPU clock of 16Mhz, well outside of ham bands for the fundamental and harmonics, TCXO with high stability
- CODEC main clock provided by the CPU PLL, high stability, very suitable for digital modes

- Constant LCD brightness, to avoid using TIMER PWM output, another way to avoid stray interference from the CPU to sensitive RF parts
- And finally simple power on/power off circuit, fully soft controlled, virtually no current draw when the transceiver is off.

A really good description of software defined radio can be found on DH1TW's web site here

There is a McHF Yahoo support group that was started by Andy (G6LBQ) here.

Most questions and updates can be found there.

### **Availability of parts**

The Boards and LCD displays can be purchased from Chris MONKA on the McHF web site. HERE

There is no kits or one place for all the components yet. On the Yahoo group there is BOM "bill of materials" lists as well as lists on the McHF site. The list is at the end of this document but does not list the part suppliers part numbers only the manufacture part number.

Most of the rest of the parts can be obtained from Farnell in the UK and Europe.

From Mouser and Digikey in the USA. Some of the power and audio jacks will need to be bought from the UK from Farnell because there is no US suppliers as of this documents date.

From the Author

This document was written by Bruce Wattendorf W1BAW and I got the design from Robbie WB5RVZ and his site WB5RVZ.org whish is a SoftRock build guide site. I can be contacted by email at bwattendorf@gmail.com.

#### **Rx Circuitry**

Description of rx circuit

TX Circuitry		
Project Schematic		
RX Schematic		
TY Schematic		

### **Project Bill of Materials**

Add links to bill of materials

### **Board Layouts**

Look for good board layouts pictures for the boards

#### **Ensemble RXTX Detailed Build Notes**

For the non-expert builders among us, this site takes you through a stage-by-stage build of the kit. Each stage is self-contained and outlines the steps to build and test the stage. This ensures that you will have a much better chance of success once you reach the last step, since you will have successfully built and tested each preceding stage before moving on to the next stage.

Each stage is listed below, in build order, and you can link to it by clicking on its name below (or in the header and/or footer of each web page).

- Build and Test the Power Supply stage.
- Build and Test the Micro processor stage.
- Build and Test the Audio stage.
- Build and Test the Local Oscillator stage.
- Build and Test the <u>Dividers</u> stage.
- Build and Test the RF I/O and Switching stage.
- Build and Test the RX Mixer (QSD) stage.

• Build and Test the <u>RX Opamps and Output</u> stage.

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### Stage-By-Stage Testing

Each stage will have a "Testing" Section, outlining one or more tests that, when successfully completed, provide you with the confidence and assurance that you are heading in the right direction towards a fully tested and built transceiver.

When you perform a test, you should always record the results of the test where indicated in the Testing section. This will make troubleshooting via the reflector much easier, since you will be communicating with the experts using a standard testing and measurement regime.

When comparing measurements to those published in these notes, the builder should be aware that actual and expected values could vary by as much as +/- 10%. The idea behind furnishing "expected/nominal" measurement values is to provide the builder with a good, "ballpark" number to determine whether or not the test has been successful. If the builder has concerns about his measurements, he should by all means pose those concerns as a query in the MCHF Yahoo group so others can provide assistance.

It goes without saying that you should ALWAYS precede any tests with a very careful, minute inspection (using the best light and magnification available to you) to be sure all solder joints are clean and there are no solder bridges or cold joints.

This radio can be built and reliably tested using nothing more than a common multimeter. Tests assume that the builder has a decent digital multimeter of sufficiently high input impedance as to minimize circuit loading issues. Measurements will be taken of current draws, test point voltages, and resistances.

Most stages will have a current draw test, in which the builder tests the stage's current draw in two different ways:

- First, testing the draw through a current-limiting resistor
- Then, when that test is OK, removing the current-limiting resistor and measuring the real current draw.

Some tests will require you to use your ham radio to receive or generate a signal of a specified frequency in order to test transmitters, oscillators, dividers, and/or receivers. Optional testing. If the builder has (access to) a dual channel oscilloscope, along with an audio signal generator and an RF signal generator, and feels the need to perform tests beyond the basic DMM tests, certain stages will include in their testing section some optional tests involving this advanced equipment.

The <u>IQGen</u> or <u>DQ-Gen</u> programs available free from Michael Keller, DL6IAK, can be used in a pinch to get the sound card to produce audio tones for injection into the circuit.

### **Completed RF board**

Top View
Bottom View

### **Completed UI board**

Top View

**Bottom View** 

### **Background Info**

### Component Identification

After soldering problems, the most common cause of trouble in radio building is the installation of the incorrect component. Most often this is the case with resistors (hint - if voltage or current draw tests are way out of whack, suspect resistors or solder bridges). Invest in a cheap multimeter and MEASURE the resistance.

### Soldering

If you are not experienced at soldering (and even if you are somewhat experienced at soldering), refer to <u>excellent tutorial on basic soldering techniques by Tom Hammond NOSS</u> (SK).

# This video provides some excellent hints at soldering (and de-soldering) SMT components:

The video below describes techniques for soldering SOIC 14 (and 16 and 8) SMDs

View the above in full-screen mode on Youtube.

You may also want to review the information from the HamNation series on George, W5JDX, and his build of the Softrock Ensemble RXTX which the MCHF was based off of. He uses an inexpensive heat gun and Solder paste to install SMT capacitors and ICs. The Session where he introduces the process is in <a href="Episode #70">Episode #70</a> at 36 minutes, 30 seconds into the podcast.

For the more adventurous, there is a process using solder paste and an electric oven called the reflow process, which can be used to install all the SMT chips to one side of the PC Board. This is documented by Guenael Jouchet in the following Youtube segment:

- Read the <u>Primer on SMT Soldering</u> at the Sparkfun site. It is a very good read and it speaks great truths. Then take the time to watch the <u>video tutorial on soldering an SOIC SMD IC</u>.
- Solder Stations. Don't skimp here. Soldering deficiencies account for 80 percent of the problems surfaced in troubleshooting. It is preferable to have an ESD-safe station, with a grounded tip. A couple of good stations that are relatively inexpensive are:



Velleman <u>VTSS5U 50W Solder Station</u> (approx \$25 at Frys) (<u>See BGMicro for Spare Tips</u>)



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#### **ESD Protection**

- Avoid carpets in cool, dry areas.
- Leave PC cards and memory modules in their anti-static packaging until ready to be installed.
- Dissipate static electricity before handling any system components (PC cards, memory modules) by touching a grounded metal object, such as the system unit unpainted metal chassis.
- If possible, use antistatic devices, such as <u>wrist straps and antistatic mats</u> (see <u>Radio</u> Shack's Set for \$25 or the JameCo AntiStatic mat for \$15)).
- Always hold a PC card or memory module by its edges. Avoid touching the contacts and components on the memory module.
- Before removing chips from insulator, put on the wrist strap connected to the ESD mat. All work with CMOS chips should be done with the wrist strap on.
- As an added precaution before first touching a chip, you should touch a finger to a grounded metal surface.
- If using a DMM, its outside should be in contact with the ground of the ESD mat, and both leads shorted to this ground before use.
- See the review of ESD Precautions at this link.

#### Work Area

- You will need a well-lit work area and a minimum of 3X magnification (the author uses a cheap magnifying fluorescent light with a 3X lens. This is supplemented by a handheld 10 X loupe - with light - for close-in inspection of solder joints and SMT installation.
- You should use a cookie sheet or baking pan (with four sides raised approximately a
  half an inch) for your actual work space. It is highly recommended for building on top
  of in order to catch stray parts, especially the tiny SMT chips which, once they are
  launched by an errant tweezer squeeze, are nigh on impossible to find if they are not
  caught on the cookie sheet.

#### Misc Tools

- It is most important to solidly clamp the PCB in a holder when soldering. A "third-hand" (e.g., <u>Panavise</u> or the <u>Hendricks kits PCB Vise</u>) can hold your board while soldering. In a pinch, you can get by with a simple <u>third-hand</u>, <u>alligator clip vise</u>. Jan GOBBL suggests "A very cheap way is to screw a Large Document Clip to a woodblock which will clamp the side of a PCB."
- Tweezers (bent tip is preferable).
- A toothpick and some beeswax these can be used to pickup SMT devices and hold them steady while soldering.
- Diagonal side cutters.
- Small, rounded jaw needle-nose pliers.
- Set of jewelers' screwdrivers
- An Exacto knife.
- Fine-grit emery paper.

- Magnifying Head Strap, or +2 to +3 reading glasses, or USB microscope (can be bought on Ebay for less them \$100.00 usd.
- 12 volt DC power supply with power meter used to measure current.

If you are going to be using the hot air gun method then the following is recommended

- solder paste can be bought from <a href="kd5ssj.com">kd5ssj.com</a> his site also has some very good tips
- hot air gun embossing guns can be bought from Ebay or amazon for less then \$20.00 USD or a professional hot air gun made for SMT electronic rework can be found for less then \$100.00 USD. The embossing gun can blow the parts out of alignment because of the air pressure where the profession air rework station normally has adjust air pressure.

# Parts 1 McHF - RF 0.4 Power Supply **Introduction**

#### General Info About the Stage

In this first (and following) stages, the builder should remember that one of the most common causes of errors is soldering. It pays to review materials on soldering, get help from Elmers, or whatever you can do to make your solder joints as clean and properly conductive as possible!

The second most common cause of errors is installation of the WRONG component and/or installing the component in the wrong ORIENTATION. The old rule of "measure twice, cut once" clearly applies to this project. When you order the parts it is recommended that you don't remove the parts from the bags they come in till you are ready to solder them and also replace any not used back in the bag to reduce this issue.

The remaining one-tenth of one percent of the causes of errors is the defective component - most suspect the component immediately; the intelligent rarely look first at possible component failure.

### Theory of Operation

mcHF uses a chain of linear regulators to provide all needed voltages. The top one is software controlled from the MCU. Linear regulators chain was chosen against switching supply for simplicity and easier EMC management.

F1 is a poly fuse that will reset when triggered, also D1 is there to prevent damage from reverse voltage.

Note that there are actually four power busses:

Voltages needed by mcHF - 12V for final PA, 8V for the speaker amp and TX quad preamp, 5V for most of the RF modules, LCD etc. and 3.3V for the digital logic - MCU and Codec. The main concern here is the voltage drop in the chain to be as small as possible because eventually it is converted to heat. As the first two regulators use the output PA transistors heatsink, this is a concern. So the drop in U3 is 12 - 8.5 = 3.5 V, the drop in U4 is 8.5 - 5 = 3.5 V and finally U5 drop is 5 - 3.3 = 1.7 V.

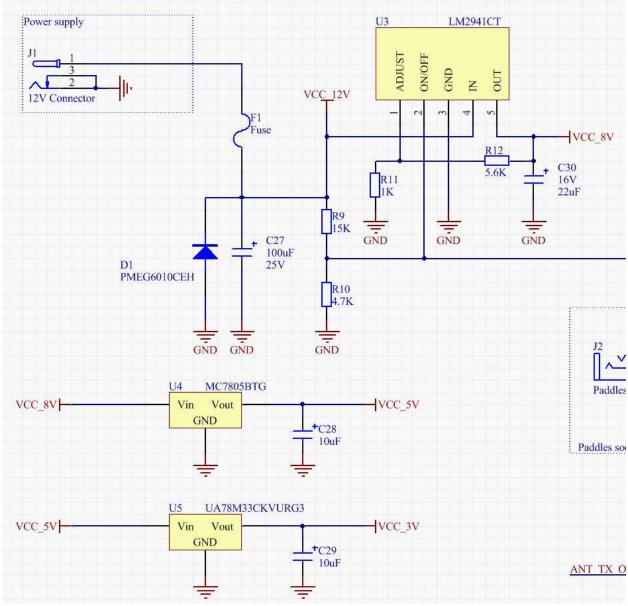
The way power up works is by holding the U3 INHIBIT pin high from the incoming 12V supply via divider R9/R10. The idle voltage is 2.6V, enough to keep the regulator in OFF mode and not give to much reverse current to the MCU GPIOs connected via D2. Pressing the power button on the UI pcb will provide low level to the pin 3 of U3, which will put the U3 in ON state, which in turn will cause the MCU to boot and execution of the startup firmware routines will provide constant low level to D2 and keep the U3 ON. Power off is just switching MCU GPIO pin to high and powering off the whole regulator chain.

The RF board uses 12 volts DC tip positive.

# **Summary Build Notes**

- 1. Install Topside Components
- 2. Test the Stage

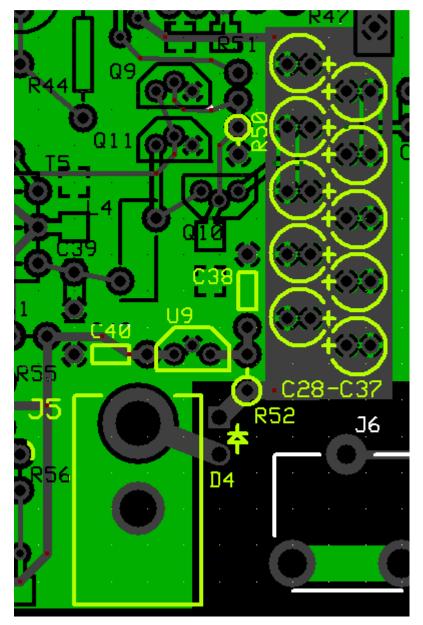
## **Stage Schematic**



Click here for full schematic

### **Board Layouts**

### **Board Top**



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### **Board Bottom**

### bottom view n/a

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# **Power Supply Bill of Materials**

Check	Part numbe r	Туре	Category	Component	Count	Marking	Image
	F1	Fuse	Ceramic	4.7 uF 10% 16V X7R RAD	1	475	
	D1	Diode	Electrolyti c	10uF/16 VDC	1		SV STO
	C27	Capacitor	Jack-RA	DC Power Jack PCB Mount (rt- angle) 2.5mm	1		0
	R11	Resistor	Plug	DC Power Plug 5.5/2.5mm Pos Ctr	1		9-3
	R12	Resistor	Axial	<u>1N4003</u>	1	1N4003 Rectifier Diode	
	C30	Capacitor	TO-92	LM78L05 voltage regulator	1	LM78L05 ESD!!!	3- Output 2 - Grid 1 - Input
	R10	Resistor	1/6W	68 1/6W 5%	1	bl-gry- blk-gld	
	R13	Resistor	1/4W	22.1 k 1/4W 1%	1	r-r-brn-r- br	-11111 =
	R14	Resistor			1		
	D2				1		
	U5				1		
	C28	Capacitor			1		
	C29	Capacitor			1		
	U4				1		
	U3				1		

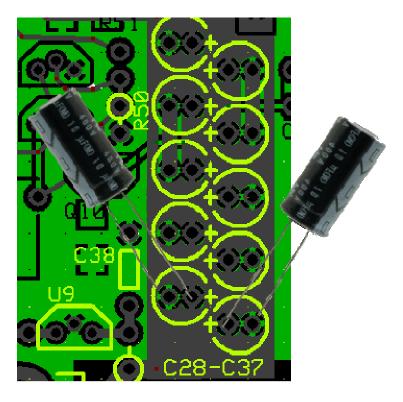
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## **Detailed Build Steps**

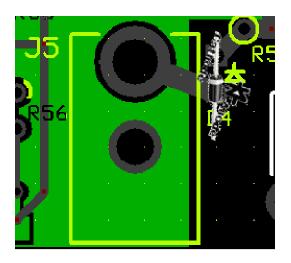
### Step\_Install Topside Components

Mount the 2 4.7 uF ceramics first and watch out for C38: the silkscreen could lead you to believe it is horizontally oriented when it actually is vertically oriented (N-S) on the board.

Pay careful attention to the polarity of the electrolytic capacitors. The positive lead is usually the longer lead; the negative lead is on the side with the grey stripe and a minus sign.



The diode's polarity is also critical. Mount it such that the cathode end of the diode (with the stripe on it) is a hairpin lead into the square hole.



Resistor R50, while not part of the power supply circuit, is installed in this stage so as to provide a convenient (regular) ground point at its hairpin lead for the tests at the end of this stage and subsequent stages.

Ch eck	Design ation	Component(to p/bottom)	Orient ation	Marking	Image	Ba nd	Notes
	P1	DC Power Plug 5.5/2.5mm Pos Ctr (top)			0-2	an y	
	C38	4.7 uF 10% 16V X7R RAD (top)	vert	475		an y	
	C40	4.7 uF 10% 16V X7R RAD (top)	horiz	475		an y	
	D4	1N4003 (top)		1N4003 Rectifier Diode		an y	Moui nt hairin style (barre l in round hole, hairpi n lead in squar

						e hole)
R52	68 1/6W 5% (top)	N-S	bl-gry-blk- gld		an y	(some kits may have 1/6W - this versio n is still OK)
U09	LM78L05 voltage regulator (top)		LM78L05 ESD!!!	3- Output 2 - Grid 1 - Inp	an y	
C28	10uF/16 VDC (top)			20 20 C	an y	
C29	10uF/16 VDC (top)			SA SIGN	an y	
C30	10uF/16 VDC (top)			SV ZEV	an y	
C31	10uF/16 VDC (top)			EN SER	an y	
C32	10uF/16 VDC (top)			N HO	an y	
C33	10uF/16 VDC (top)			30 MO.	an y	
C34	10uF/16 VDC (top)			30 310 A	an y	
C35	10uF/16 VDC (top)			20 310 A	an y	
C36	10uF/16 VDC (top)			20 31C	an y	
C37	10uF/16 VDC (top)			SV STOP	an y	
R50	22.1 k 1/4W 1% (top)	N-S	r-r-brn-r- br	=11111 =	an y	Instal led and used

					as (regul ar) groun d refere nce.
J5	DC Power Jack PCB Mount (rt- angle) 2.5mm (top)		000	an y	2.5m m ID

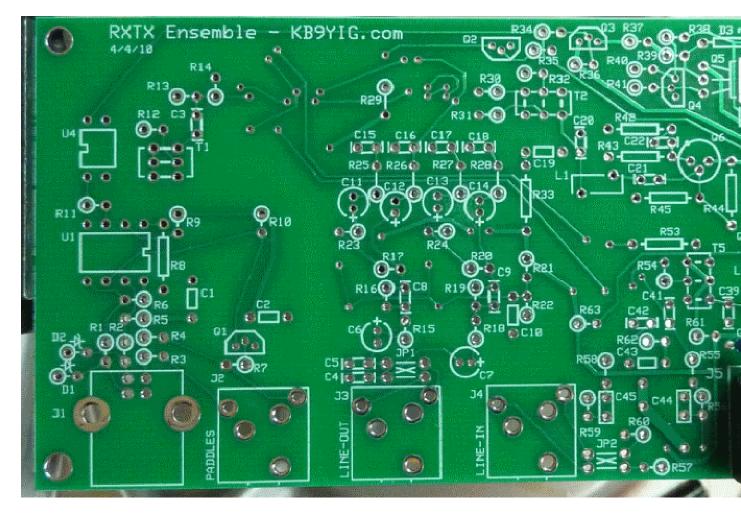
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### **Completed Photos**

Note: the completed pictures are of the 40m option, which the author built. Other band options (which the author did not build) will appear slightly different (especially the inductors, whose windings and cores will vary by band) for the band-specific components.

Also note that this board was a pre-production board and some component placements are slightly different from those on the production boards.

**View of Completed Topside** 



**View of Completed Underside** 

## (photo intentionally omitted)

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### **Progressive Schematic**

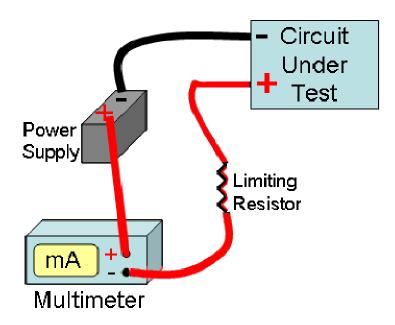
Where are we in our progress towards the finish line? Click <u>here</u> to view the entire schematic with the completed stages shaded in a yellowish tinge and the remaining stages tinted in blue (the current stage is untinted).

# Test the Power Supply Stage Power Supply - Current draw

Before applying power for the first time, test the resistance across the 12V power rail (positive lead at the point marked for the non-hairpin end of R52; negative lead on a convenient ground (see diagram below)). You should see a very high resistance (over 50 k ohms) and it should climb (as the electrolytic capacitors charge up with the ohmmeter's voltage). Ultimately, you should see an extremely high (or infinite) resistance.

Once you have successfully passed the resistance test, put your mA meter in series with the input voltage positive line and measure the current draw of the power supply.

See <u>Tutorial on Measuring Current</u> for an illustration of how to measure current in a circuit.



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Test Steps (if any)

Step	Test Point	UOM	Nominal	Author's	Builder's
2	Current draw	mA	< 8	4.5	

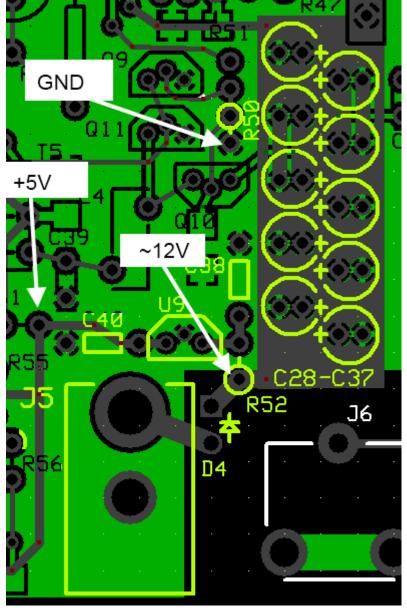
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# **Power Supply - Voltage Tests**

Power up the board with a 12V supply (no limiting resistor) and measure the voltage at the test points indicated.

(Author's measurements below were taken using power from a gel cel whose voltage measured 12.9V)

Voltage measurements are WRT regular ground. For this test you can use the "hairpin" of R50 as a convenient regular ground test point.



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### Test Steps (if any)

Step	Test Point	UOM	Nominal	Author's	Builder's
0	Hairpin lead (hole) of R61 (wrt ground)	V dc	5 (+/- 2%)	4.94	
1	Hairpin lead of D4 (wrt ground) - (with 12.9 V	V dc	12	12.3	

gelcell)	

# MCHF RF board 0.4 - Component Inventory:

This page provides a list of components This is helpful for kits where the kit includes all parts necessary to build any particular band-specific option (there would, in such cases, likely be excess parts left over at the end of the build).

Once these quantities check out, you can sort the components out to their respective build stages.

Quantit y	Componen t Type	Category	Component	Photo
□ 2	Band- specific	Omit	omit for this band	
□ 1	boardhdw	HDW	#4 nylon washer	
□ 1	boardhdw	HDW	4 X #4-40 hdw (nut, bolt, washer, spacer)	
□ 1	Capacitor	Ceramic	22 pF 5%	
□ 1	Capacitor	Ceramic	47 pF 5%	1860
□ 2	Capacitor	Ceramic	82 pF	HEL
□ 2	Capacitor	Ceramic	100 pF 5%	藝

□ 2	Capacitor	Ceramic	150 pF 5%	150
□ 2	Capacitor	Ceramic	180 pF 5%	The state of the s
□ 2	Capacitor	Ceramic	220 pF 5%	235
□ 1	Capacitor	Ceramic	270 pF 5%	
□ 2	Capacitor	Ceramic	330 pF 5%	
□ 2	Capacitor	Ceramic	390 pF 5%	
□ 2	Capacitor	Ceramic	470 pF 5%	No. of Concession, Name of
□ 1	Capacitor	Ceramic	560 pF	
□ 1	Capacitor	Ceramic	680 pF 5%	081
□ 1	Capacitor	Ceramic	820 pF 5%	
□ 3	Capacitor	Ceramic	1000 pF 5%	
□ 2	Capacitor	Ceramic	2200 pF 5%	

□ 1	Capacitor	Ceramic	4700 pF 5%	
□ 1	Capacitor	Ceramic	5600 pF 5%	
□ 1	Capacitor	Ceramic	0.01 uF	
□ 4	Capacitor	Ceramic	0.022 uF 5%	
□ 2	Capacitor	Ceramic	0.047 uF 5%	
□ 7	Capacitor	Ceramic	4.7 uF 10% 16V X7R RAD	
□ 17	Capacitor	Electrolyti c	10uF/16 VDC	SV Ziv
□ 11	Capacitor	SMT 1206	<u>0.01 uF</u>	
□ 22	Capacitor	SMT 1206	<u>0.1 uF</u>	*****
□ 1	Connector	BNC-RA	bnc connector pcb (rt-angle)	a lap
□ 3	connector	Jack-RA	3.5mm stereo jack - PCB mount (rt- angle)	
□ 1	Connector	Jack-RA	DC Power Jack PCB Mount (rt- angle) 2.5mm	

□ 1	connector	Jack-RA	USB-B pcb jack (rt-angle)	
□ 1	Connector	Plug	DC Power Plug 5.5/2.5mm Pos Ctr	0-3
□ 1	connector	Socket	socket, machine, 8 pin	
□ 2	Diode	Axial	<u>1N4003</u>	
□ 2	Diode	Axial	BZX55C3V3 3.3V zener diode	
□ 1	Heatsink	Misc	TO-220 heatsink Silpad	
□ 1	heatsink	TO-18	heatsink for driver transistor	
□ 1	Heatsink	TO-220	TO-220 heatsink for flat transistors	
□ 1	IC	DIP 8	ATtiny 85-20 PU w/V15.12 Firmware	

□ 1	IC	DIP-4	LTV-817 Opto-Isolator	
□ 1	IC	I2C	Si570 Programmable Oscillator	TDS TOS TOS TOS TOS TOS TOS TOS TOS TOS TO
□ 1	IC	SOIC-14	74AC74 Dual D FF	₹ 78C49NM AC74 <u>G4</u>
□ 2	IC	SOIC-16	FST3253 mux/demux switch	
□ 2	IC	SOIC-8	TLV2462CD dual opamp	2462C 3581T CY5T
□ 1	IC	SOIC-8	LT6231 dual op-amp	47 622 6231
□ 1	IC	SOT-23-5	LP2992AIM5 -3.3V regulator	
□ 1	IC	TO-92	LM78L05 voltage regulator	3- Output 2 - Grid 1 - Input

□ 5	inductor	Binocular core	BN-43-2402 (no markings!)	
□ 3	inductor	Binocular core	BN-61-2402 (no Markings!)	00
□ 1	Inductor	Choke	4T #26 on BN-43-2402	
□ 2	Inductor	Coil	0.36uH: 11T #26 on T37-6 (yellow)	You wind it
□ 2	Inductor	Coil	0.6uH: 14T #26 on T37-6 (yellow)	You wind it
□ 1	Inductor	Coil	0.53uH 14T #30 on T25- 6(yellow)	You wind it
□ 1	Inductor	Coil	0.78uH 17T #30 on T25-6 (yellow)	You wind it
□ 1	Inductor	Coil	0.9uH 18T #30 on T25- 6(yellow)	You wind it
□ 2	inductor	Coil	0.9uH: 15T #26(10 in) on T37-2 (red)	You wind it
□ 2	Inductor	coil	1.3uH: 18T #26(12in) on T37-2(red)	You wind it
□ 2	inductor	Coil	1.4uH: 19T #26 on T37-2 (red) 12"	You wind it
□ 1	Inductor	Coil	1.6uH: 22T #30 on T25-2 (red)	You wind it
□ 1	Inductor	Coil	1.6uH 21T #30 on T30-6 (yellow)	You wind it
□ 1	Inductor	Coil	18.7uH: 66T #30 on T30-2 (red)	You wind it
□ 1	Inductor	Coil	2.1uH 24T #30 on T30-6	You wind it

			(yellow)	
□ 1	Inductor	Coil	2.3uH 25T #30 on T30-6 (yellow)	You wind it
□ 2	inductor	Coil	2.5uH: 29T #26(17in) on T37-6 (yel)	You wind it
□ 2	Inductor	Coil	3.4uH: 29T #26 on T37-2 (red)	You wind it
□ 1	Inductor	Coil	4.7uH 33T #30 on T30-2 (red)	You wind it
□ 1	Inductor	Coil	30uH 83T #30 on T30-2 (red)	You wind it
□ 2	inductor	Toroid	T25-2 toroid core	
□ 2	inductor	Toroid	T25-6 toroid core	
□ 4	inductor	Toroid	T30-2 toroid core	
□ 2	inductor	Toroid	T30-6 toroid core	
□ 2	inductor	Toroid	T37-6 toroid core	
□ 2	inductor	Toroid	T37-2 toroid core	
□ 1	Inductor	Xfrmr	0.81uH 8T bifilar/15T #30 on T30-6 (yellow)	You wind it
□ 1	Inductor	Xfrmr	0.13uH: 7T/2x4T bifilar #30 on T25-6	You wind it

			(yellow)	
<b>1</b>	inductor	Xfrmr	0.6uH: 14T/2x7T bifilar #30 on T25-6 (yellow) 8"	You wind it
□ 1	inductor	Xfrmr	0.69uH: 16T/2x8T bifilar #30 on T25-6 (yellow) 9"	You wind it
□ 1	Inductor	Xfrmr	1.2uH: 18T/2x9T bifilar #30 on T25-2 (red)	You wind it
□ 1	Inductor	Xfrmr	1.4uH: 18T/2x9T bifilar #30 on T30-2 (red)	You wind it
□ 1	Inductor	Xfrmr	1.74uH 11T bifilar/22T #30 on T30- 6(yellow)	You wind it
□ 1	Inductor	Xfrmr	2.43uH 13T(bi)/26T #30 on T30-6 (yellow)	You wind it
□ 1	Inductor	xfrmr	4T bifilar #30 on BN-61- 2402	You wind it
□ 1	Inductor	Xfrmr	5.0uH 17T bidfilar/34T #30 on T30-2 (red)	You wind it
□ 1	Inductor	Xfrmr	2T Bifilar #30 on BN-43- 2402	You wind it
□ 1	Inductor	Xfrmr	3T bifilar/5T #30 0n BN- 61-2402	You wind it
□ 1	Inductor	Xfrmr	7.1uH 20T bifilar/40T #30 on T30-2 (red)	You wind it
□ 1	Inductor	Xfrmr	6T/3T bifilar	You wind it

	1		#30 on BN-	
			<u>#30 011 BIN-</u> 61-2402	
□ 1	Inductor	Xfrmr	6T/3T bifilar #30 on BN- 43-2402	You wind it
□ 1	Inductor	xfrmr	4T bifilar #30 on BN-43- 2402	You wind it
□ 1	Inductor	Xfrmr	4T bifilar/5T #30 0n BN- 43-2402	You wind it
□ 1	Inductor	Xfrmr	5T/3T bifilar #30 on BN- 61-2402	You wind it
□ 2	Resistor	1/4W	2.2 ohm 1/4W 5%	- <b>H</b>
□ 2	Resistor	1/4W	10 ohm 1/4W 1%	
□ 1	Resistor	1/4W	22.1 ohm 1%	
□ 1	Resistor	1/4W	33.2 ohm 1%	- <b>       </b> -
□ 8	Resistor	1/4W	49.9 ohm 1%	
□ 1	Resistor	1/4W	56.2 1/4W 1%	-         -
□ 1	Resistor	1/4W	68.1 1/4W 1%	
□ 3	Resistor	1/4W	221 1/4W 1%	
□ 2	Resistor	1/4W	475 1/4W 1%	
□ 3	Resistor	1/4W	1 k 1/4W 1%	=
□ 5	Resistor	1/4W	2.21 k 1/4W 1%	-11111 =
□ 1	Resistor	1/4W	3.32 k 1/4W 1%	
□ 5	Resistor	1/4W	4.99 k 1/4W 1%	
□ 11	Resistor	1/4W	10 k 1/4W 1%	
□ 3	Resistor	1/4W	22.1 k 1/4W 1%	
□ 4	Resistor	1/6W	68 1/6W 5%	
□ 2	Resistor	1/6W	100 1/6W 5%	-
□ 4	Resistor	1/6W	2.2k 1/6W 5%	-
□ 3	Resistor	1/6W	4.7k 1/6W 5%	
□ 1	resistor	1/6W	100k 1/6W 5%	-111 =

□ 1	Resistor	1/6W	1 M 1/6W 5%	-       -
□ 1	SET	HDW	#6 screw, hex nut, starwasher	
□ 1	Transistor	TO-18	2N2222 NPN transistor	
□ 2	Transistor	ТО-92	2N3904 NPN Transistor	C B E TO-92
□ 2	Transistor	TO-92	2N3906 PNP transistor	C B E TO-92
□ 6	Transistor	TO-92	BS170 N- Channel Enhancement Mode FET	BS170
□ 4	wire	Cutoff	shunt wire (cut-off lead)	

# McHF UI board 0.4 - Component Inventory:

This page provides a list of components and their maximum quantities to support your inventorying the kit as a whole. This is helpful for kits where the kit includes all parts necessary to build any particular band-specific option (there would, in such cases, likely be excess parts left over at the end of the build).

Once these quantities check out, you can sort the components out to their respective build stages.

Quantit y	Componen t Type	Category	Component	Photo
□ 2	Band- specific	Omit	omit for this band	
□ 1	boardhdw	HDW	#4 nylon washer	
□ 1	boardhdw	HDW	4 X #4-40 hdw (nut, bolt, washer, spacer)	
□ 1	Capacitor	Ceramic	22 pF 5%	
□ 1	Capacitor	Ceramic	47 pF 5%	1260
□ 2	Capacitor	Ceramic	82 pF	MZJ MZJ
□ 2	Capacitor	Ceramic	100 pF 5%	10000000000000000000000000000000000000
□ 2	Capacitor	Ceramic	150 pF 5%	II'S
□ 2	Capacitor	Ceramic	180 pF 5%	The state of the s
□ 2	Capacitor	Ceramic	220 pF 5%	285

□ 1	Capacitor	Ceramic	270 pF 5%	
□ 2	Capacitor	Ceramic	330 pF 5%	
□ 2	Capacitor	Ceramic	390 pF 5%	I Sime
□ 2	Capacitor	Ceramic	470 pF 5%	The state of the s
□ 1	Capacitor	Ceramic	560 pF	
□ 1	Capacitor	Ceramic	680 pF 5%	081
□ 1	Capacitor	Ceramic	820 pF 5%	
□ 3	Capacitor	Ceramic	1000 pF 5%	
□ 2	Capacitor	Ceramic	2200 pF 5%	
□ 1	Capacitor	Ceramic	4700 pF 5%	
□ 1	Capacitor	Ceramic	5600 pF 5%	
□ 1	Capacitor	Ceramic	0.01 uF	
□ 4	Capacitor	Ceramic	0.022 uF 5%	

□ 2	Capacitor	Ceramic	0.047 uF 5%	
□ 7	Capacitor	Ceramic	4.7 uF 10% 16V X7R RAD	
□ 17	Capacitor	Electrolyti c	10uF/16 VDC	SV STVA
□ 11	Capacitor	SMT 1206	<u>0.01 uF</u>	
□ 22	Capacitor	SMT 1206	<u>0.1 uF</u>	****
□ 1	Connector	BNC-RA	bnc connector pcb (rt-angle)	
□ 3	connector	Jack-RA	3.5mm stereo jack - PCB mount (rt- angle)	
□ 1	Connector	Jack-RA	DC Power Jack PCB Mount (rt- angle) 2.5mm	0
□ 1	connector	Jack-RA	USB-B pcb jack (rt-angle)	7177
□ 1	Connector	Plug	DC Power Plug 5.5/2.5mm Pos Ctr	9-3
□ 1	connector	Socket	socket, machine, 8 pin	

□ 2	Diode	Axial	<u>1N4003</u>	
□ 2	Diode	Axial	BZX55C3V3 3.3V zener diode	
□ 1	Heatsink	Misc	TO-220 heatsink Silpad	
□ 1	Heatsink	TO-18	heatsink for driver transistor	
□ 1	Heatsink	TO-220	TO-220 heatsink for flat transistors	
□ 1	IC	DIP 8	ATtiny 85-20 PU w/V15.12 Firmware	
□ 1	IC	DIP-4	LTV-817 Opto-Isolator	
□ 1	IC	I2C	Si570 Programmable Oscillator	Sitabs 57.0 CA20001416 CA20001416 DND

□ 1	IC	SOIC-14	74AC74 Dual D FF	₹ 78C49NM AC74 <u>G4</u>
□ 2	IC	SOIC-16	FST3253 mux/demux switch	
□ 2	IC	SOIC-8	TLV2462CD dual opamp	2462C 3581T CY5T
□ 1	IC	SOIC-8	LT6231 dual op-amp	47 622 6231
□ 1	IC	SOT-23-5	LP2992AIM5 -3.3V regulator	
□ 1	IC	ТО-92	LM78L05 voltage regulator	3- Output 2 - Grid 1 - Input
□ 5	Inductor	Binocular core	BN-43-2402 (no markings!)	
□ 3	Inductor	Binocular core	BN-61-2402 (no Markings!)	00
□ 1	Inductor	Choke	4T #26 on BN-43-2402	
□ 2	Inductor	Coil	0.36uH: 11T #26 on T37-6 (yellow)	You wind it
□ 2	Inductor	Coil	0.6uH: 14T #26 on T37-6 (yellow)	You wind it

□ 1	Inductor	Coil	0.53uH 14T #30 on T25- 6(yellow)	You wind it
□ 1	Inductor	Coil	0.78uH 17T #30 on T25-6 (yellow)	You wind it
□ 1	Inductor	Coil	0.9uH 18T #30 on T25- 6(yellow)	You wind it
□ 2	Inductor	Coil	0.9uH: 15T #26(10 in) on T37-2 (red)	You wind it
□ 2	Inductor	coil	1.3uH: 18T #26(12in) on T37-2(red)	You wind it
□ 2	Inductor	Coil	1.4uH: 19T #26 on T37-2 (red) 12"	You wind it
□ 1	Inductor	Coil	1.6uH: 22T #30 on T25-2 (red)	You wind it
□ 1	Inductor	Coil	1.6uH 21T #30 on T30-6 (yellow)	You wind it
□ 1	Inductor	Coil	18.7uH: 66T #30 on T30-2 (red)	You wind it
□ 1	Inductor	Coil	2.1uH 24T #30 on T30-6 (yellow)	You wind it
□ 1	Inductor	Coil	2.3uH 25T #30 on T30-6 (yellow)	You wind it
□ 2	Inductor	Coil	2.5uH: 29T #26(17in) on T37-6 (yel)	You wind it
□ 2	Inductor	Coil	3.4uH: 29T #26 on T37-2 (red)	You wind it
□ 1	Inductor	Coil	4.7uH 33T #30 on T30-2 (red)	You wind it
□ 1	Inductor	Coil	30uH 83T #30 on T30-2 (red)	You wind it

□ 2	Inductor	Toroid	T25-2 toroid core	
□ 2	Inductor	Toroid	T25-6 toroid core	
□ 4	Inductor	Toroid	T30-2 toroid core	
□ 2	Inductor	Toroid	T30-6 toroid core	
□ 2	Inductor	Toroid	T37-6 toroid core	
□ 2	Inductor	Toroid	T37-2 toroid core	
□ 1	Inductor	Xfrmr	0.81uH 8T bifilar/15T #30 on T30-6 (yellow)	You wind it
□ 1	Inductor	Xfrmr	0.13uH: 7T/2x4T bifilar #30 on T25-6 (yellow)	You wind it
□ 1	Inductor	Xfrmr	0.6uH: 14T/2x7T bifilar #30 on T25-6 (yellow) 8"	You wind it
□ 1	Inductor	Xfrmr	0.69uH: 16T/2x8T bifilar #30 on T25-6 (yellow) 9"	You wind it
□ 1	Inductor	Xfrmr	1.2uH: 18T/2x9T bifilar #30 on T25-2 (red)	You wind it

□ 1	Inductor	Xfrmr	1.4uH: 18T/2x9T bifilar #30 on T30-2 (red)	You wind it
□ 1	Inductor	Xfrmr	1.74uH 11T bifilar/22T #30 on T30- 6(yellow)	You wind it
□ 1	Inductor	Xfrmr	2.43uH 13T(bi)/26T #30 on T30-6 (yellow)	You wind it
□ 1	Inductor	xfrmr	4T bifilar #30 on BN-61- 2402	You wind it
□ 1	Inductor	Xfrmr	5.0uH 17T bidfilar/34T #30 on T30-2 (red)	You wind it
□ 1	Inductor	Xfrmr	2T Bifilar #30 on BN-43- 2402	You wind it
□ 1	Inductor	Xfrmr	3T bifilar/5T #30 0n BN- 61-2402	You wind it
□ 1	Inductor	Xfrmr	7.1uH 20T bifilar/40T #30 on T30-2 (red)	You wind it
□ 1	Inductor	Xfrmr	6T/3T bifilar #30 on BN- 61-2402	You wind it
□ 1	Inductor	Xfrmr	6T/3T bifilar #30 on BN- 43-2402	You wind it
□ 1	Inductor	xfrmr	4T bifilar #30 on BN-43- 2402	You wind it
□ 1	Inductor	Xfrmr	4T bifilar/5T #30 0n BN- 43-2402	You wind it
□ 1	Inductor	Xfrmr	5T/3T bifilar #30 on BN- 61-2402	You wind it
□ 2	Resistor	1/4W	2.2 ohm 1/4W	-

	<u> </u>		<b>5</b> 0/	
			5%	
□ 2	Resistor	1/4W	10 ohm 1/4W 1%	-
□ 1	Resistor	1/4W	22.1 ohm 1%	
□ 1	Resistor	1/4W	33.2 ohm 1%	
□ 8	Resistor	1/4W	49.9 ohm 1%	
□ 1	Resistor	1/4W	56.2 1/4W 1%	_
□ 1	Resistor	1/4W	68.1 1/4W 1%	- <b>FIRS</b> -
□ 3	Resistor	1/4W	221 1/4W 1%	
□ 2	Resistor	1/4W	475 1/4W 1%	
□ 3	Resistor	1/4W	1 k 1/4W 1%	
□ 5	Resistor	1/4W	2.21 k 1/4W 1%	
□ 1	Resistor	1/4W	3.32 k 1/4W 1%	-11111 =
□ 5	Resistor	1/4W	4.99 k 1/4W 1%	
□ 11	Resistor	1/4W	10 k 1/4W 1%	
□ 3	Resistor	1/4W	22.1 k 1/4W 1%	
□ 4	Resistor	1/6W	68 1/6W 5%	
$\square$ 2	Resistor	1/6W	100 1/6W 5%	
□ 4	Resistor	1/6W	2.2k 1/6W 5%	<b>— III</b> I —
□ 3	Resistor	1/6W	4.7k 1/6W 5%	
□ 1	Resistor	1/6W	100k 1/6W 5%	-111 =
□ 1	Resistor	1/6W	1 M 1/6W 5%	<b>- III</b>
□1	SET	HDW	#6 screw, hex nut, starwasher	
□ 1	Transistor	TO-18	2N2222 NPN transistor	
□ 2	Transistor	TO-92	2N3904 NPN Transistor	C B E TO-92

□ 2	Transistor	TO-92	2N3906 PNP transistor	C B E TO-92
□6	Transistor	TO-92	BS170 N- Channel Enhancement Mode FET	BS170
□ 4	Wire	Cutoff	shunt wire (cut-off lead)	